

PATENT ASSIGNMENT

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Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Seung-Hoon Lee</td><td>09/04/2006</td></tr><tr><td>Jonni Ahlgren</td><td>09/11/2006</td></tr><tr><td>Jukka Jakara</td><td>09/14/2006</td></tr><tr><td>Aarto Paren</td><td>09/26/2006</td></tr><tr><td>Jukka Rautiainen</td><td>10/04/2006</td></tr><tr><td>Ilkka Renvall</td><td>10/06/2006</td></tr></tbody></table>	Name	Execution Date	Seung-Hoon Lee	09/04/2006	Jonni Ahlgren	09/11/2006	Jukka Jakara	09/14/2006	Aarto Paren	09/26/2006	Jukka Rautiainen	10/04/2006	Ilkka Renvall	10/06/2006	
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Ilkka Renvall	10/06/2006														
RECEIVING PARTY DATA															
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City:	Helsinki														
State/Country:	FINLAND														
Postal Code:	FI-00180														
PROPERTY NUMBERS Total: 1															
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>10587564</td></tr></tbody></table>	Property Type	Number	Application Number:	10587564											
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CORRESPONDENCE DATA															
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CH \$40.00 10587564

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PATENT
REEL: 019423 FRAME: 0791

NAME OF SUBMITTER:

Leah M. Reimer

Total Attachments: 2

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ASSIGNMENT

WHEREAS We, **Seung-Hoon Lee** of 206-307, Plaza APT, 762-2, Anyang 9 dong, Anyang City, Kyunggi-do, Republic of Korea; **Jonni Ahlgren** of Karitie 11 F 45, FI-65230, Vaasa, Finland; **Jukka Jäkärä** of Vasamantie 12, FI-33450 Siivikkala, Finland; **Aarto Parén** of Verkkokatu 3 A 5, FI-65230 Vaasa, Finland; **Jukka Rautiainen** of Säterinkatu 9 A 19, FI-02600 Espoo, Finland and **Ilkka Renvall** of Puronvarsi 4 B, FI-02300 Espoo, Finland (hereinafter referred to as "ASSIGNORS") have invented certain new and useful improvements in:

**A PROCESS FOR THE TREATMENT OF FIBRE MATERIAL
AND NEW COMPOSITION**

which claims priority to **Finland** Application No. 20040293, filed February 25, 2004, and for which We are about to file or have filed an application for Letters Patent of the United States;

AND WHEREAS, **Kemira Oyj** (hereinafter referred to as "ASSIGNEE"), a limited company organized and existing under the laws of the Country of **Finland**, having a place of business at **Porkkalankatu 3, FI-00180, Helsinki, Finland**, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do

hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: <u>04.09.2006</u>	<u>SH Lee</u> L.S. Seung-Hoon Lee
Date: <u>11.9.2006</u>	<u>Jonni Ahlgren</u> L.S. Jonni Ahlgren
Date: <u>14.9.2006</u>	<u>Jukka Jäkärä</u> L.S. Jukka Jäkärä
Date: <u>26.9.06</u>	<u>Aarto Parén</u> L.S. Aarto Parén
Date: <u>04.10.2006</u>	<u>Jukka Rautiainen</u> L.S. Jukka Rautiainen
Date: <u>6.10.2006</u>	<u>Ilkka Renvall</u> L.S. Ilkka Renvall